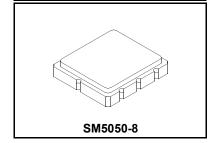
Preliminary



RFM products are now Murata products.

SF2222C

228.0 MHz **SAW Filter**



· Low Insertion Loss

- Excellent Size-to-Performance Ratio
- Hermetic SM5050-8 Surface-mount Case
- · Single-ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

| Rating | Value | Units |
|--|----------------|-------|
| Maximum Power Handling | 1 | W |
| Maximum DC Voltage on any Non-ground Terminal 3 V | | VDC |
| Storage Temperature Range in Tape and Reel | -40 to +85 | °C |
| Suitable for Lead-free Soldering - Maximum Soldering Profile | 260°C for 30 s | |

Electrical Specifications

| Characteristic | Sym | Notes | Min | Тур | Max | Units |
|--------------------------------------|----------------|-------|-----|-------|-----|-------------------|
| Center Frequency | f _C | | | 228.0 | | MHz |
| Insertion Loss, 224.9 to 231.1 MHz | | | | | 3.0 | dB |
| Amplitude Ripple, 224.9 to 231.1 MHz | | | | | 1.2 | dB _{P-P} |
| Rejection: | | | | | | |
| 1.0 to 150.0 MHz | | | 50 | | | |
| 150.0 to 195.0 MHz | | | 40 | | | 1 |
| 195.0 to 210.0 MHz | | | 30 | | | 1 |
| 250.0 to 275.0 MHz | | | 35 | | | dB |
| 275.0 to 320.0 MHz | | | 35 | | | |
| 320.0 to 1000.0 MHz | | | TBD | | | 1 |
| 1000.0 to 3000.0 MHz | | | TBD | | | 1 |
| Source Impedance, Single-ended | | | | 50 | | Ω |
| Load Impedance, Single-ended | | | | 50 | | Ω |
| Operating Temperature Range | T _A | | -40 | | +85 | °C |

| Case Style | SM5050-8, 5 x 5 mm Nominal Footprint |
|--|--------------------------------------|
| Lid Symbolization (YY = year, WW = week) | 958, YYWW |

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.

- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.

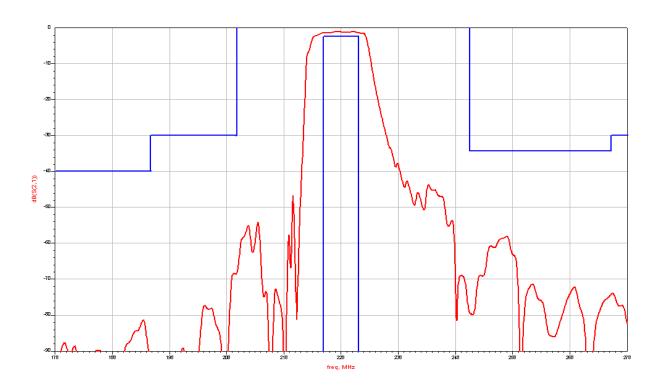
 The turnover temperature, T_O, is the temperature of maximum (or turnover) frequency, f_O. The nominal frequency at any case temperature, T_C, may
- be calculated from: $f=f_0[1-FTC(T_0-T_c)^2]$.

The design, manufacturing process, and specifications of this filter are subject to change.

Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.

US and international patents may apply.

Frequency Response Plot

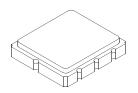


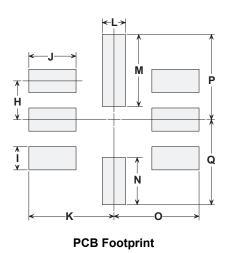
Terminal Connections

| Connection | | Terminals | | |
|---------------------|--------|--------------|--|--|
| Port 1 | Input | 2 | | |
| Port 2 | Output | 6 | | |
| | Ground | All others | | |
| Operation | | Single-ended | | |
| Dot indicates Pin 1 | | | | |

SM5050-8 Case

8-Terminal Ceramic Surface-Mount Case 5.0 X 5.0 mm Nominal Footprint



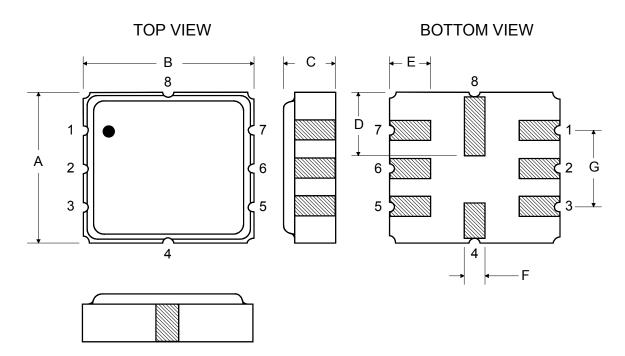


Case Dimensions

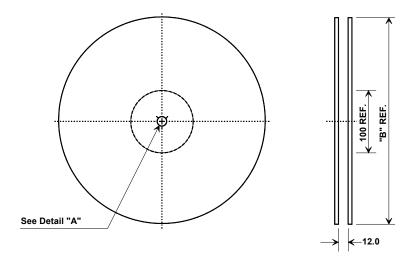
| Dimension | mm | | | Inches | | |
|-------------|------|------|------|--------|-------|-------|
| Dilliension | Min | Nom | Max | Min | Nom | Max |
| Α | 4.80 | 5.00 | 5.20 | 0.189 | 0.197 | 0.205 |
| В | 4.80 | 5.00 | 5.20 | 0.189 | 0.197 | 0.205 |
| С | 1.30 | 1.50 | 1.70 | 0.050 | 0.060 | 0.067 |
| D | 1.98 | 2.08 | 2.18 | 0.078 | 0.082 | 0.086 |
| E | 1.07 | 1.17 | 1.27 | 0.042 | 0.046 | 0.050 |
| F | 0.50 | 0.64 | 0.70 | 0.020 | 0.025 | 0.028 |
| G | 2.39 | 2.54 | 2.69 | 0.094 | 0.100 | 0.106 |
| Н | | 1.27 | | | 0.050 | |
| I | | 0.76 | | | 0.030 | |
| J | | 1.55 | | | 0.061 | |
| K | | 2.79 | | | 0.110 | |
| L | | 0.76 | | | 0.030 | |
| М | | 2.36 | | | 0.093 | |
| N | | 1.55 | | | 0.061 | |
| 0 | | 2.79 | _ | | 0.110 | |
| P | | 2.79 | | | 0.110 | |
| Q | | 2.79 | | | 0.110 | |

Case Material

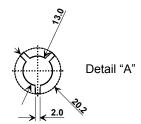
| Materials | | | | |
|-----------------------|--|--|--|--|
| Solder Pad Plating | 0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel | | | |
| Lid Plating | 2.0 to 3.0 µm Nickel | | | |
| Body | Al ₂ O ₃ Ceramic | | | |
| Pb Free | | | | |



Tape and Reel Specifications



| "B" Nominal Size | | Quantity Per Reel | |
|---------------------|-------------|-------------------|--|
| Inches | millimeters | | |
| 7 | 178 | 500 | |
| 13 | 330 | 3000 | |



COMPONENT ORIENTATION and DIMENSIONS

| Carrier Tape Dimensions | | | |
|-------------------------|---------|--|--|
| Ao | 5.3 mm | | |
| Во | 5.3 mm | | |
| Ko | 2.0 mm | | |
| Pitch | 8.0 mm | | |
| W | 12.0 mm | | |

